

FCP7N60N / FCPF7N60NT

N-Channel MOSFET

600V, 6.8A, 0.52Ω

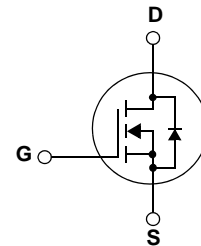
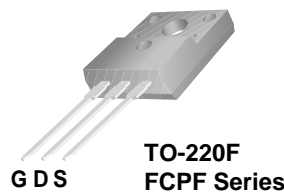
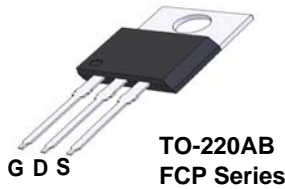
Features

- $R_{DS(on)} = 0.46\Omega$ (Typ.) @ $V_{GS} = 10V, I_D = 3.4A$
- Ultra Low Gate Charge (Typ. $Q_g = 17.8nC$)
- Low Effective Output Capacitance
- 100% Avalanche Tested
- RoHS Compliant

Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class R_{sp} , superior switching performance and ruggedness.

This SupreMOS MOSFET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.



MOSFET Maximum Ratings $T_C = 25^\circ C$ unless otherwise noted

Symbol	Parameter	FCP7N60N	FCPF7N60NT	Units
V_{DSS}	Drain to Source Voltage	600		V
V_{GSS}	Gate to Source Voltage	±30		V
I_D	Drain Current	-Continuous ($T_C = 25^\circ C$)	6.8	6.8*
		-Continuous ($T_C = 100^\circ C$)	4.3	4.3*
I_{DM}	Drain Current	- Pulsed (Note 1)	20.4	20.4
E_{AS}	Single Pulsed Avalanche Energy (Note 2)	79.4		mJ
I_{AR}	Avalanche Current	6.8		A
E_{AR}	Repetitive Avalanche Energy	0.6		mJ
dv/dt	MOSFET dv/dt Ruggedness	100		V/ns
	Peak Diode Recovery dv/dt (Note 3)	4.9		V/ns
P_D	Power Dissipation	($T_C = 25^\circ C$)	64.1	30.5
		- Derate above $25^\circ C$	0.51	0.24
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150		°C
T_L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300		°C

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCP7N60N	FCPF7N60NT	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.95	4.1	°C/W
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	0.5	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCP7N60N	FCP7N60N	TO-220AB	-	-	50
FCPF7N60NT	FCPF7N60NT	TO-220F	-	-	50

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 1\text{mA}, V_{GS} = 0\text{V}, T_C = 25^\circ\text{C}$	600	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 1\text{mA}$, Referenced to 25°C	-	0.6	-	$\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 480\text{V}, V_{GS} = 0\text{V}$	-	-	10	μA
		$V_{DS} = 480\text{V}, V_{GS} = 0\text{V}, T_C = 125^\circ\text{C}$	-	-	100	
I_{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$	-	-	± 100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	2.0	-	4.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\text{V}, I_D = 3.4\text{A}$	-	0.46	0.52	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 20\text{V}, I_D = 3.4\text{A}$	-	8.5	-	S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 100\text{V}, V_{GS} = 0\text{V}$ $f = 1\text{MHz}$	-	719	960	pF
C_{oss}	Output Capacitance		-	30	40	pF
C_{riss}	Reverse Transfer Capacitance		-	2.1	3.2	pF
C_{oss}	Output Capacitance	$V_{DS} = 380\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	-	17	-	pF
$C_{oss,eff}$	Effective Output Capacitance	$V_{DS} = 0\text{V to } 380\text{V}, V_{GS} = 0\text{V}$	-	91	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DS} = 380\text{V}, I_D = 3.4\text{A}$ $V_{GS} = 10\text{V}$	-	17.8	35.6	nC
Q_{gs}	Gate to Source Gate Charge		-	3.2	6.3	nC
Q_{gd}	Gate to Drain "Miller" Charge		(Note 4)	-	6.0	11.9
ESR	Equivalent Series Resistance (G-S)	Drain Open	-	2.5	-	Ω

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 380\text{V}, I_D = 3.4\text{A}$ $R_G = 4.7\Omega$	-	12	24	ns
t_r	Turn-On Rise Time		-	6	22	ns
$t_{d(off)}$	Turn-Off Delay Time		-	35	80	ns
t_f	Turn-Off Fall Time		(Note 4)	-	12	24

Drain-Source Diode Characteristics

I_S	Maximum Continuous Drain to Source Diode Forward Current	-	-	6.8	A	
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current	-	-	20.4	A	
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_{SD} = 3.4\text{A}$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0\text{V}, I_{SD} = 3.4\text{A}$	-	211	-	ns
Q_{rr}	Reverse Recovery Charge	$di_F/dt = 100\text{A}/\mu\text{s}$	-	1.8	-	μC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. $I_{AS} = 2.3\text{A}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{SD} \leq 6.8\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq 380\text{V}$, Starting $T_J = 25^\circ\text{C}$
4. Essentially Independent of Operating Temperature Typical Characteristics

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Typical Performance Characteristics

Figure 1. On-Region Characteristics

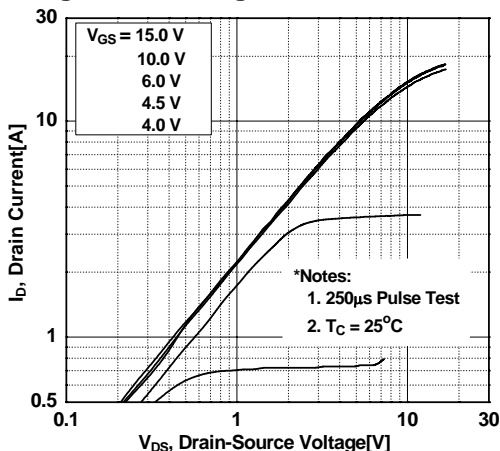


Figure 2. Transfer Characteristics

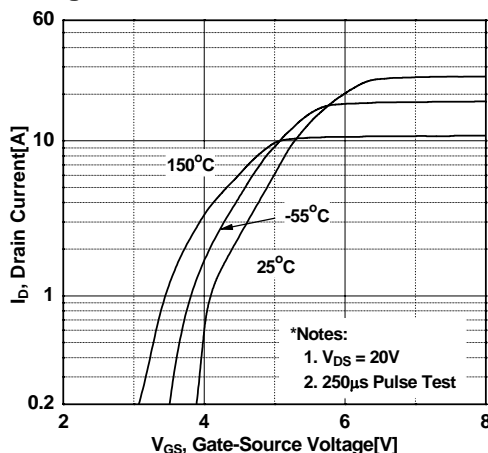


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

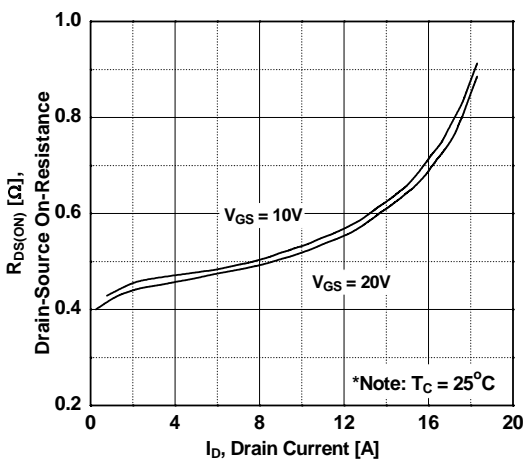


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

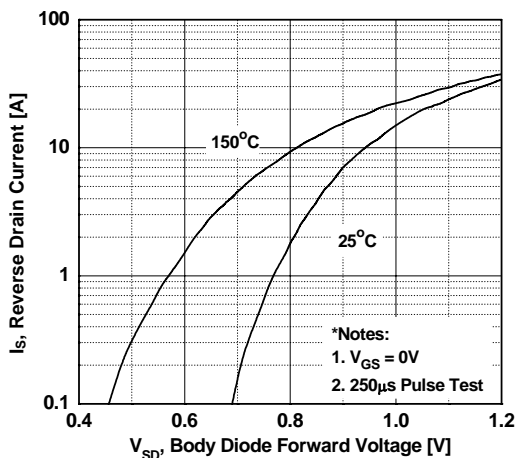


Figure 5. Capacitance Characteristics

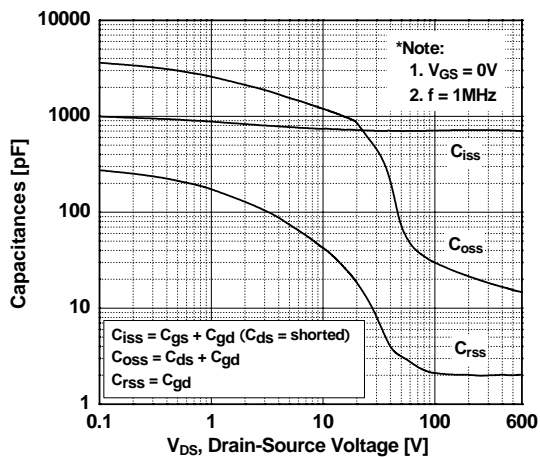
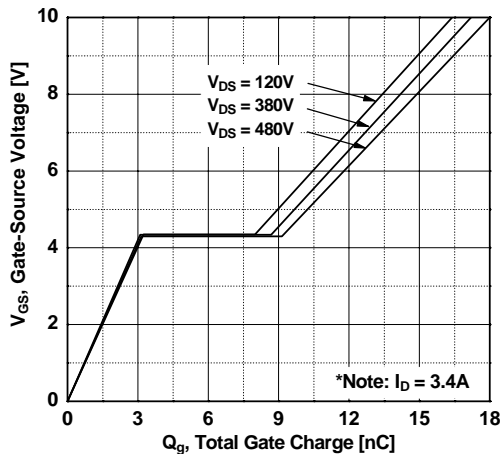


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

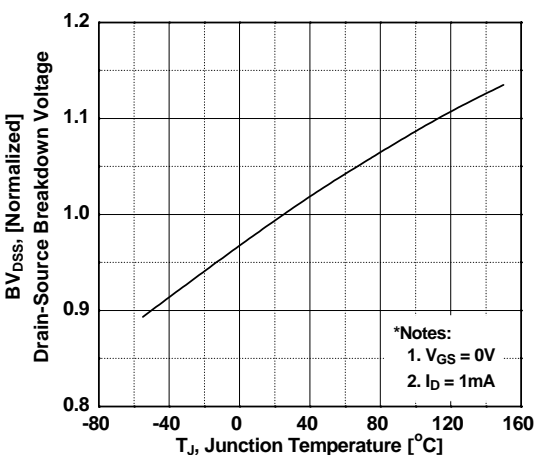


Figure 8. On-Resistance Variation vs. Temperature

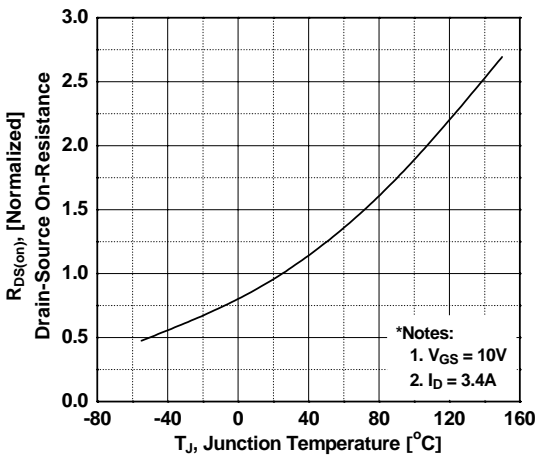


Figure 9. Maximum Safe Operating Area - FCP7N60N

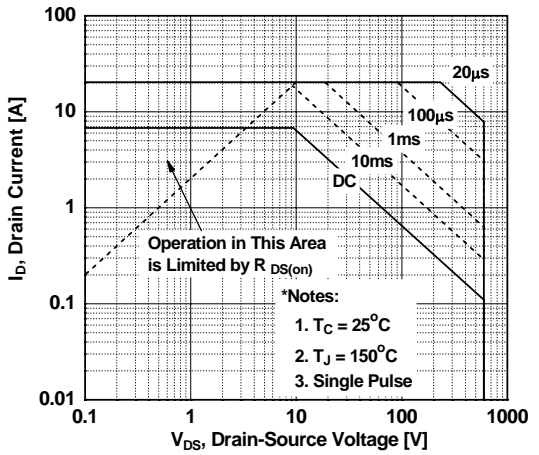


Figure 10. Maximum Safe Operating Area - FCPF7N60NT

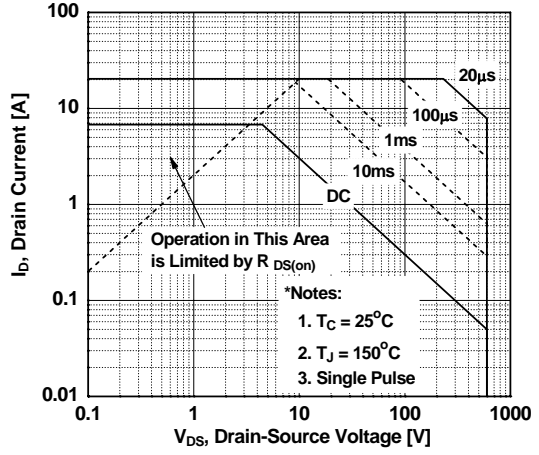


Figure 11. Maximum Drain Current vs. Case Temperature

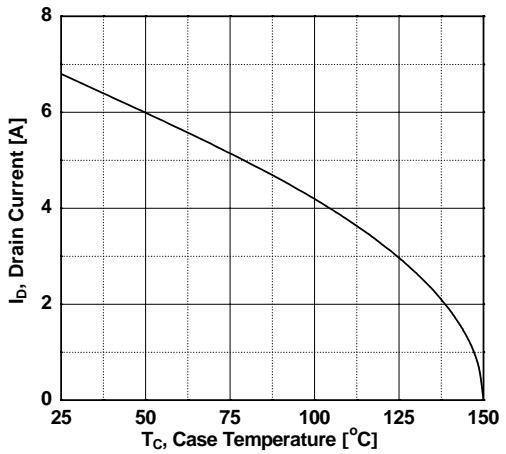


Figure 12. Transient Thermal Response Curve _ FCP7N60N

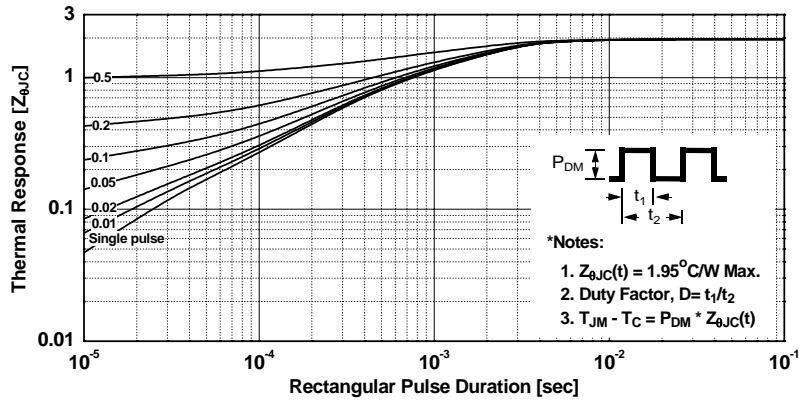
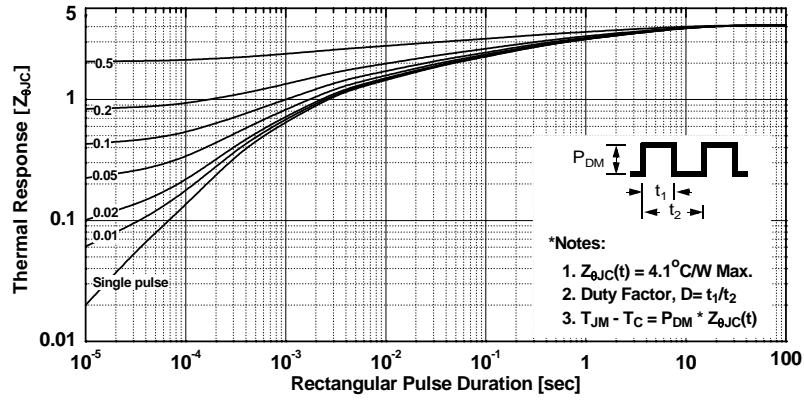
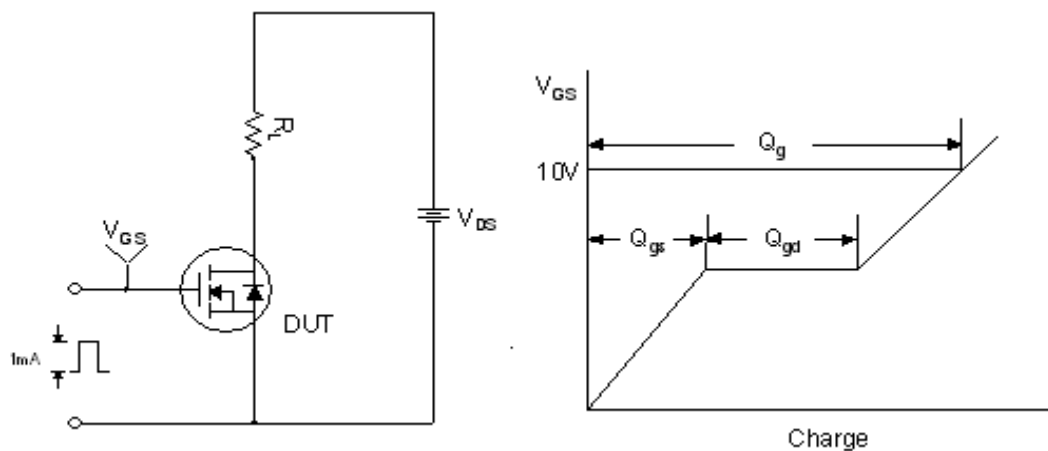


Figure 13. Transient Thermal Response Curve _ FCPF7N60NT

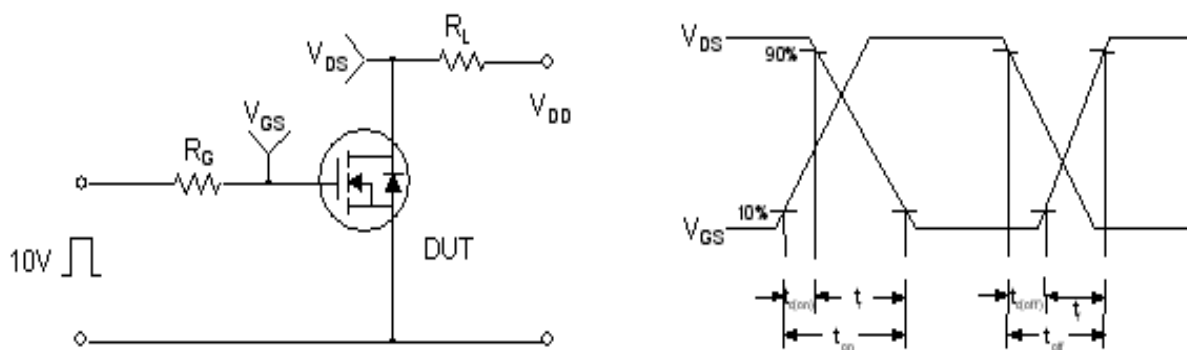


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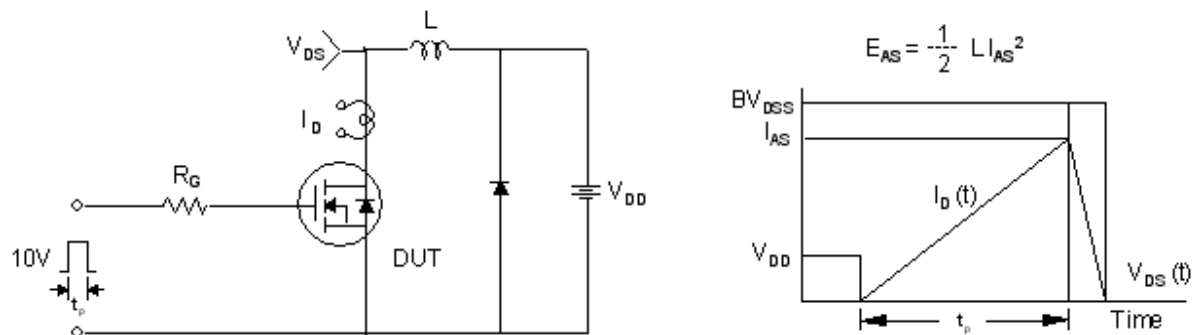
Gate Charge Test Circuit & Waveform



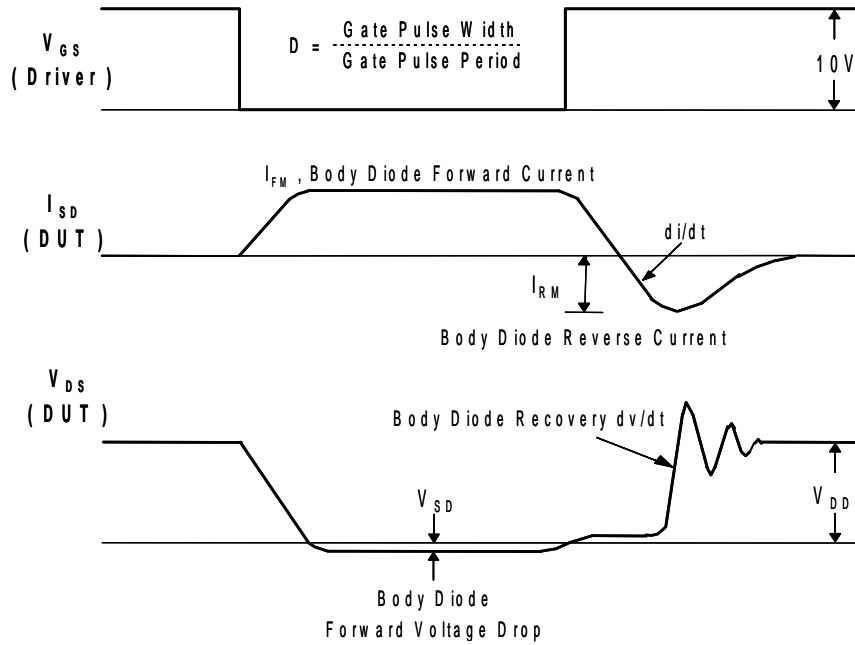
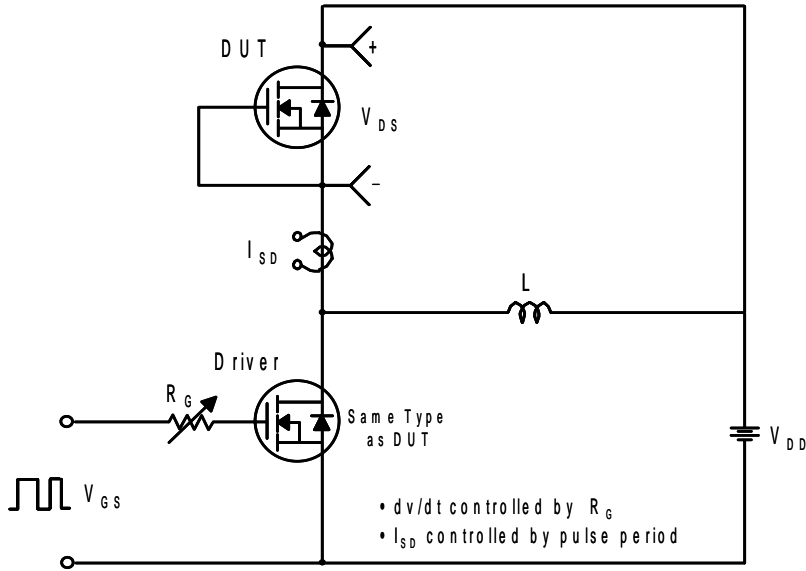
Resistive Switching Test Circuit & Waveforms



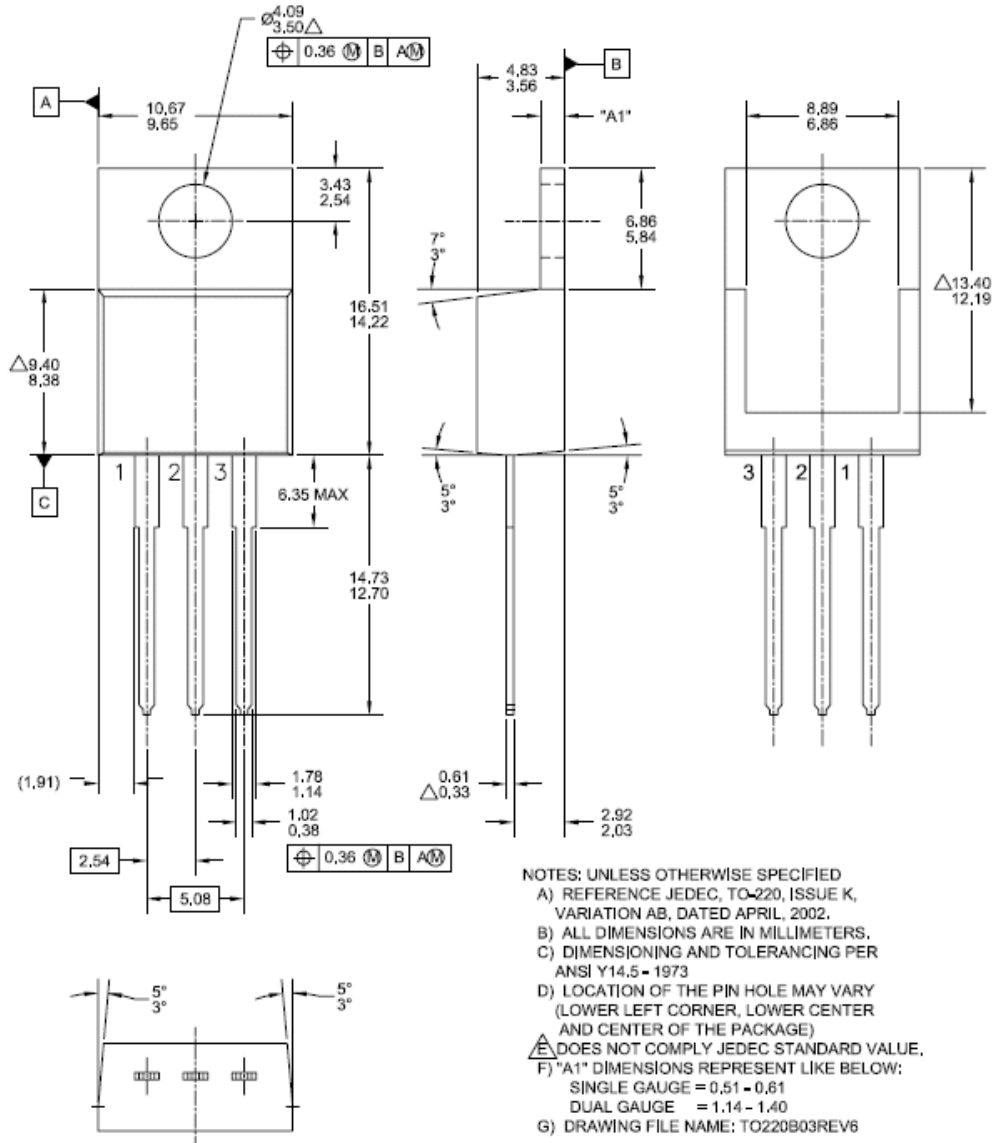
Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms



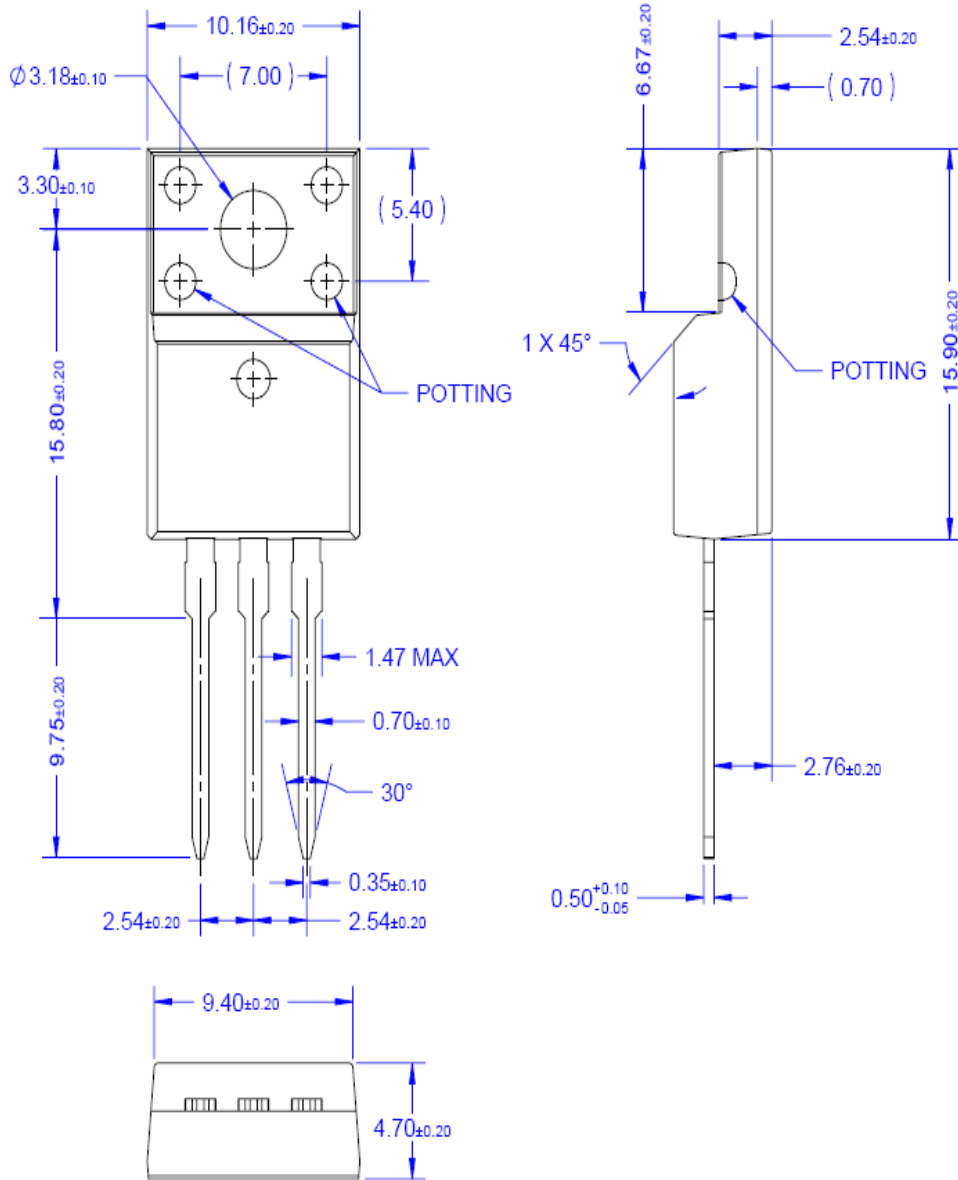
TO-220AB



Dimensions in Millimeters

Mechanical Dimensions

TO-220F








Dimensions in Millimeters

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